



DISCRETE POWER DIODES and THYRISTORS

DATA BOOK



ST173C..C SERIES

INVERTER GRADE THYRISTORS

Hockey Puk Version

Features

- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- All diffused design
- Center amplifying gate
- Guaranteed high dV/dt
- Guaranteed high dI/dt
- High surge current capability
- Low thermal impedance
- High speed performance

Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters

330A



case style TO-200AB (A-PUK)

Major Ratings and Characteristics

| Parameters | ST173C..C | Units |
|-------------------|--------------|-------------------|
| $I_{T(AV)}$ | 330 | A |
| | @ T_{hs} | °C |
| $I_{T(RMS)}$ | 610 | A |
| | @ T_{hs} | °C |
| I_{TSM} | @ 50Hz | A |
| | @ 60Hz | A |
| I^2t | @ 50Hz | KA ² s |
| | @ 60Hz | KA ² s |
| V_{DRM}/V_{RRM} | 1000 to 1200 | V |
| t_q range | 15 to 30 | μs |
| T_J | - 40 to 125 | °C |

ST173C..C Series

ELECTRICAL SPECIFICATIONS

Voltage Ratings

| Type number | Voltage Code | V_{DRM}/V_{RRM} , maximum repetitive peak voltage V | V_{RSM} , maximum non-repetitive peak voltage V | I_{DRM}/I_{RRM} max. @ $T_J = T_{J\max}$ mA |
|-------------|--------------|---|---|---|
| ST173C..C | 10 | 1000 | 1100 | 40 |
| | 12 | 1200 | 1300 | |

Current Carrying Capability

| Frequency | | | | | Units |
|----------------------------------|--------------|--------------|--------------|--------------|------------|
| 50Hz | 760 | 660 | 1200 | 1030 | 5570 |
| 400Hz | 730 | 590 | 1260 | 1080 | 2800 |
| 1000Hz | 600 | 490 | 1200 | 1030 | 1620 |
| 2500Hz | 350 | 270 | 850 | 720 | 800 |
| Recovery voltage V_r | 50 | 50 | 50 | 50 | 50 |
| Voltage before turn-on V_d | V_{DRM} | V_{DRM} | V_{DRM} | V_{DRM} | V |
| Rise of on-state current dI/dt | 50 | 50 | - | - | A/ μ s |
| Heatsink temperature | 40 | 55 | 40 | 55 | °C |
| Equivalent values for RC circuit | 47Ω / 0.22μF | 47Ω / 0.22μF | 47Ω / 0.22μF | 47Ω / 0.22μF | |

On-state Conduction

| Parameter | ST173C..C | Units | Conditions |
|---|-----------|--------------------|--|
| $I_{T(AV)}$ Max. average on-state current @ Heatsink temperature | 330 (120) | A | 180° conduction, half sine wave double side (single side) cooled |
| | 55 (85) | °C | |
| $I_{T(RMS)}$ Max. RMS on-state current | 610 | A | DC @ 25°C heatsink temperature double side cooled |
| I_{TSM} Max. peak, one half cycle, non-repetitive surge current | 4680 | | Sinusoidal half wave, Initial $T_J = T_{J\max}$ |
| | 4900 | | |
| | 3940 | | |
| | 4120 | | |
| I^2t Maximum I^2t for fusing | 110 | KA ² s | Initial $T_J = T_{J\max}$ |
| | 100 | | |
| | 77 | | |
| | 71 | | |
| $I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing | 1100 | KA ² /s | $t = 0.1$ to 10ms, no voltage reapplied |

ST173C..C Series

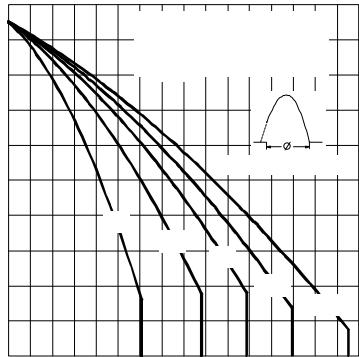


Fig. 3 - Current Ratings Characteristics

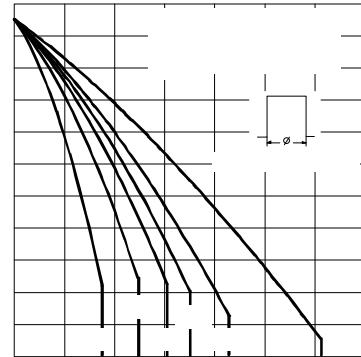


Fig. 4 - Current Ratings Characteristics

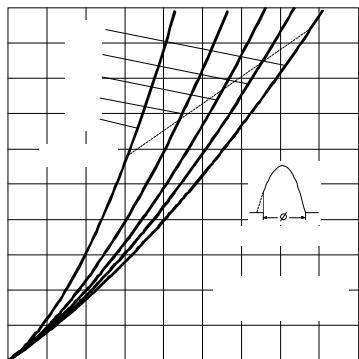


Fig. 5 - On-state Power Loss Characteristics

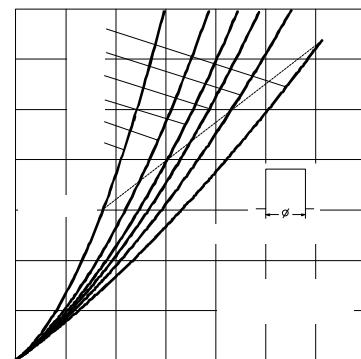


Fig. 6 - On-state Power Loss Characteristics

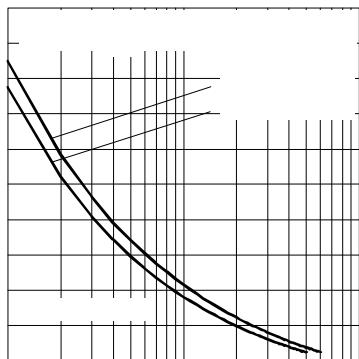


Fig. 7 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

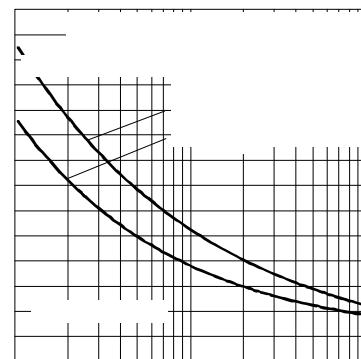


Fig. 8 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

ST173C..C Series

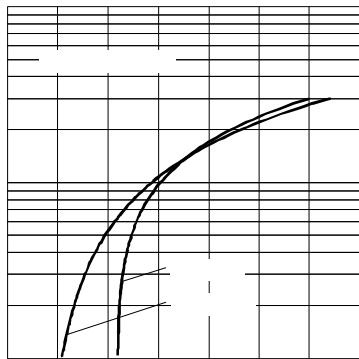


Fig. 9 - On-state Voltage Drop Characteristics

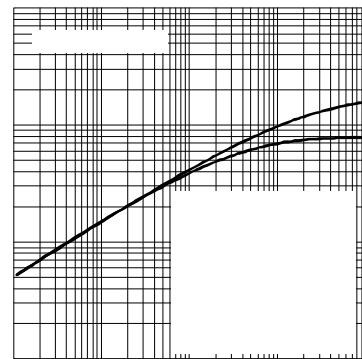


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

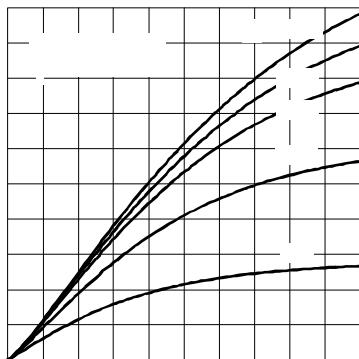


Fig. 11 - Reverse Recovered Charge Characteristics

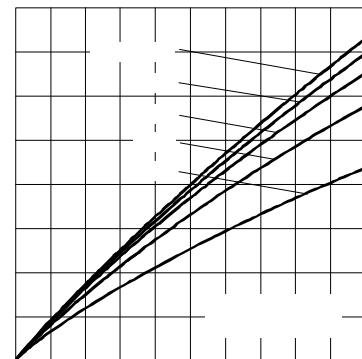


Fig. 12 - Reverse Recovery Current Characteristics

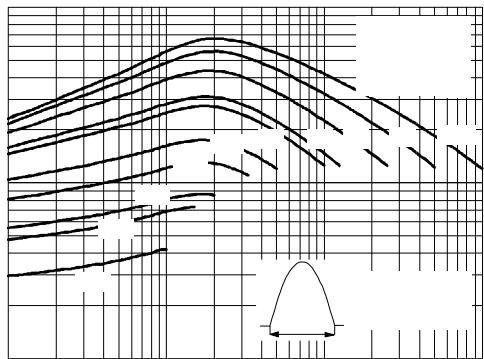


Fig. 13 - Frequency Characteristics

ST173C..C Series

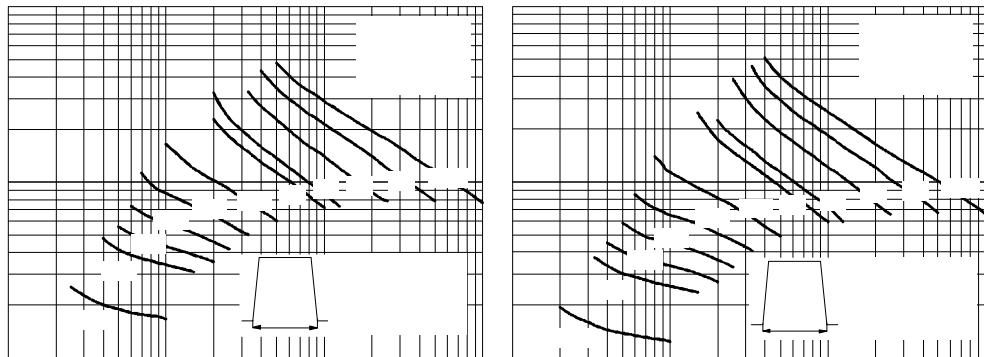


Fig. 14 - Frequency Characteristics

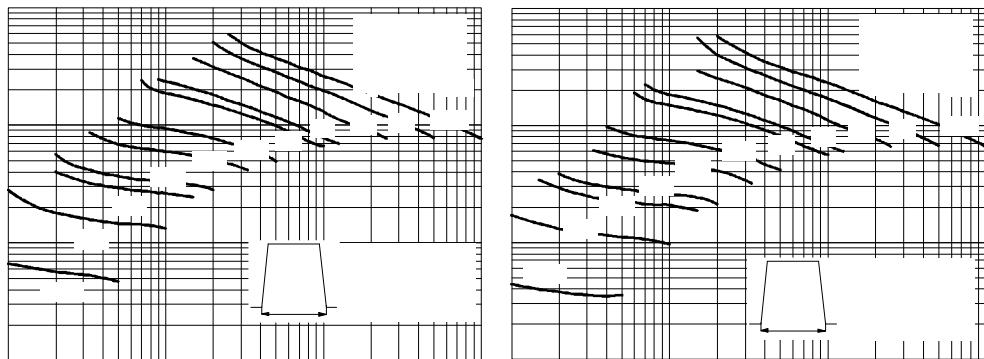


Fig. 15 - Frequency Characteristics

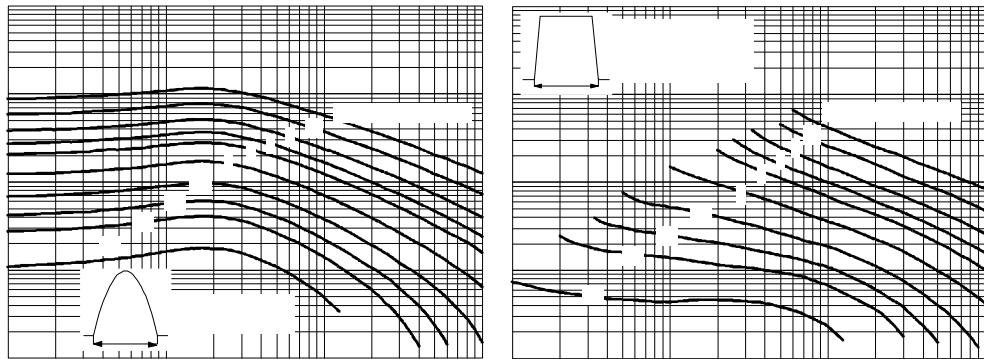


Fig. 16 - Maximum On-state Energy Power Loss Characteristics

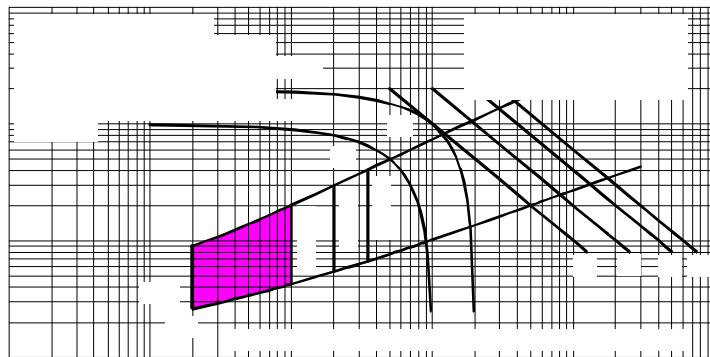


Fig. 17 - Gate Characteristics

ST173C..C Series

On-state Conduction

| Parameter | ST173C..C | Units | Conditions | |
|--------------|--|-------|------------------|---|
| V_{TM} | Max. peak on-state voltage | 2.07 | V | $I_{TM} = 600A, T_J = T_J \text{ max}, t_p = 10\text{ms sine wave pulse}$ |
| $V_{T(TO)1}$ | Low level value of threshold voltage | 1.55 | | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$ |
| $V_{T(TO)2}$ | High level value of threshold voltage | 1.61 | | $(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$ |
| r_{t1} | Low level value of forward slope resistance | 0.87 | $\text{m}\Omega$ | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$ |
| r_{t2} | High level value of forward slope resistance | 0.77 | | $(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$ |
| I_H | Maximum holding current | 600 | mA | $T_J = 25^\circ\text{C}, I_T > 30\text{A}$ |
| I_L | Typical latching current | 1000 | | $T_J = 25^\circ\text{C}, V_A = 12\text{V}, R_a = 6\Omega, I_G = 1\text{A}$ |

Switching

| Parameter | ST173C..C | Units | Conditions | |
|-----------|---|---------------|------------------------|---|
| di/dt | Max. non-repetitive rate of rise of turned-on current | 1000 | $\text{A}/\mu\text{s}$ | $T_J = T_J \text{ max}, V_{DRM} = \text{rated } V_{DRM}$ $I_{TM} = 2 \times di/dt$ |
| t_d | Typical delay time | 1.1 | | $T_J = 25^\circ\text{C}, V_{DM} = \text{rated } V_{DRM}, I_{TM} = 50\text{A DC}, t_p = 1\mu\text{s}$ Resistive load, Gate pulse: 10V, 5Ω source |
| t_q | Max. turn-off time | Min 15 Max 30 | | $T_J = T_J \text{ max}, I_{TM} = 300\text{A}, \text{commutating } di/dt = 20\text{A}/\mu\text{s}$ $V_R = 50\text{V}, t_p = 500\mu\text{s}, dv/dt: \text{see table in device code}$ |

Blocking

| Parameter | ST173C..C | Units | Conditions |
|------------------------|--|-------|---|
| dv/dt | Maximum critical rate of rise of off-state voltage | 500 | $T_J = T_J \text{ max. linear to 80\% } V_{DRM}, \text{ higher value available on request}$ |
| I_{RRM} I_{DRM} | Max. peak reverse and off-state leakage current | 40 | $T_J = T_J \text{ max, rated } V_{DRM}/V_{RRM} \text{ applied}$ |

Triggering

| Parameter | ST173C..C | Units | Conditions | |
|-------------|--|-------|------------|---|
| P_{GM} | Maximum peak gate power | 60 | W | $T_J = T_J \text{ max, } f = 50\text{Hz, d\% = 50}$ |
| $P_{G(AV)}$ | Maximum average gate power | 10 | | |
| I_{GM} | Max. peak positive gate current | 10 | A | $T_J = T_J \text{ max, } t_p \leq 5\text{ms}$ |
| $+V_{GM}$ | Maximum peak positive gate voltage | 20 | | |
| $-V_{GM}$ | Maximum peak negative gate voltage | 5 | V | $T_J = T_J \text{ max, } t_p \leq 5\text{ms}$ |
| I_{GT} | Max. DC gate current required to trigger | 200 | | |
| V_{GT} | Max. DC gate voltage required to trigger | 3 | V | $T_J = 25^\circ\text{C}, V_A = 12\text{V}, R_a = 6\Omega$ |
| I_{GD} | Max. DC gate current not to trigger | 20 | mA | $T_J = T_J \text{ max, rated } V_{DRM} \text{ applied}$ |
| V_{GD} | Max. DC gate voltage not to trigger | 0.25 | | |

ST173C..C Series

Thermal and Mechanical Specification

| Parameter | ST173C..C | Units | Conditions |
|---------------------|---|-------------------|------------|
| T _J | Max. operating temperature range | -40 to 125 | °C |
| T _{stg} | Max. storage temperature range | -40 to 150 | |
| R _{thJ-hs} | Max. thermal resistance, junction to heatsink | 0.17 0.08 | K/W |
| | | | |
| R _{thC-hs} | Max. thermal resistance, case to heatsink | 0.033 0.017 | K/W |
| | | | |
| F | Mounting force, ± 10% | 4900 (500) | N (Kg) |
| wt | Approximate weight | 50 | g |
| Case style | TO - 200AB (A-PUK) | See Outline Table | |

ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

| Conduction angle | Sinusoidal conduction | | Rectangular conduction | | Units | Conditions |
|------------------|-----------------------|-------------|------------------------|-------------|-------|--------------------------------------|
| | Single Side | Double Side | Single Side | Double Side | | |
| 180° | 0.015 | 0.016 | 0.011 | 0.011 | K/W | T _J = T _j max. |
| 120° | 0.018 | 0.019 | 0.019 | 0.019 | | |
| 90° | 0.024 | 0.024 | 0.026 | 0.026 | | |
| 60° | 0.035 | 0.035 | 0.036 | 0.037 | | |
| 30° | 0.060 | 0.060 | 0.060 | 0.061 | | |

Ordering Information Table

| Device Code | ST | 17 | 3 | C | 12 | C | H | K | 1 | |
|-------------|--|----|---|---|----|---|---|---|---|----|
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
| 1 | - Thyristor | | | | | | | | | |
| 2 | - Essential part number | | | | | | | | | |
| 3 | - 3 = Fast turn off | | | | | | | | | |
| 4 | - C = Ceramic Puk | | | | | | | | | |
| 5 | - Voltage code: Code x 100 = V _{RRM} (See Voltage Rating Table) | | | | | | | | | |
| 6 | - C = Puk Case TO-200AB (A-PUK) | | | | | | | | | |
| 7 | - Reapplied dv/dt code (for t _q test condition) | | | | | | | | | |
| 8 | - t _q code | | | | | | | | | |
| 9 | - 0 = Eyelet term. (Gate and Aux. Cathode Unsoldered Leads) 1 = Fast-on term. (Gate and Aux. Cathode Unsoldered Leads) 2 = Eyelet term. (Gate and Aux. Cathode Soldered Leads) 3 = Fast-on term. (Gate and Aux. Cathode Soldered Leads) | | | | | | | | | |
| 10 | - Critical dv/dt: None = 500V/μsec (Standard value) L = 1000V/μsec (Special selection) | | | | | | | | | |

| dv/dt - t _q combinations available | | | | | |
|---|----|----|-----|------|-----|
| dv/dt (V/μs) | 20 | 50 | 100 | 200 | 400 |
| 15 | CL | -- | -- | -- | -- |
| 18 | CP | DP | EP | FP * | -- |
| 20 | CK | DK | EK | FK * | HK |
| 25 | CJ | DJ | EJ | FJ | HJ |
| 30 | -- | DH | EH | FH | HH |

*Standard part number.
All other types available only on request.

ST173C..C Series

Outline Table

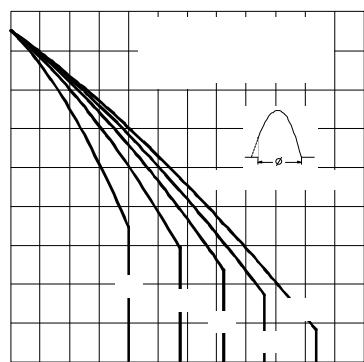
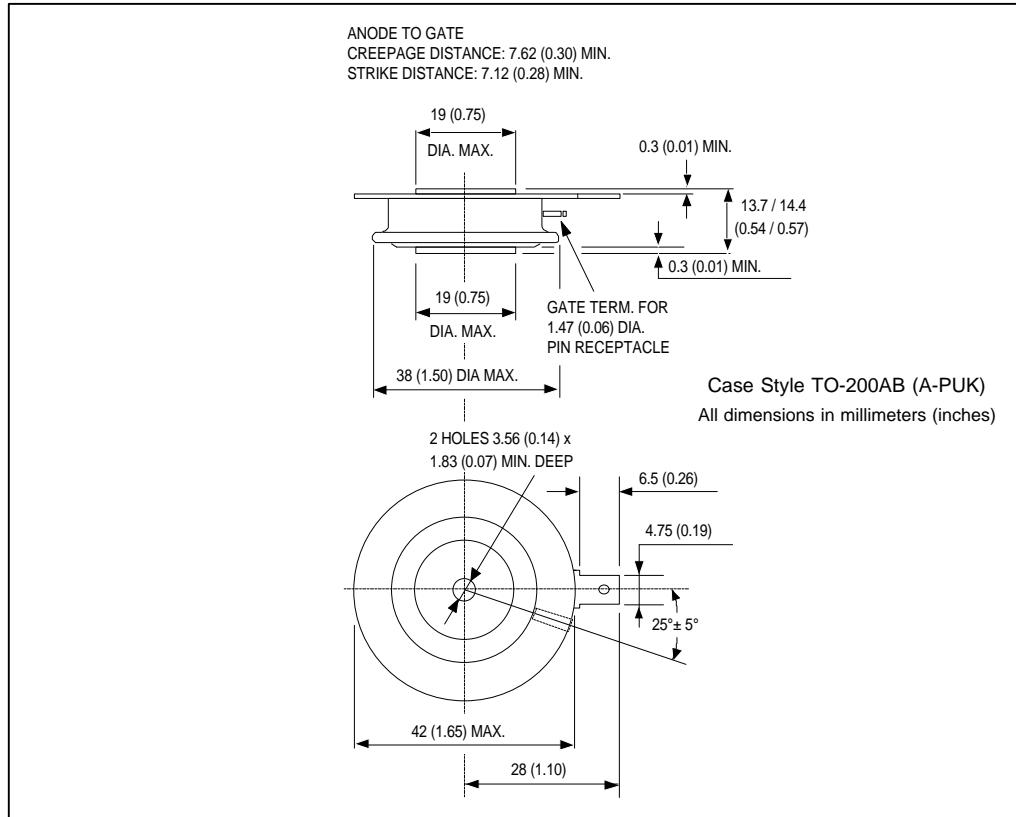


Fig. 1 - Current Ratings Characteristics

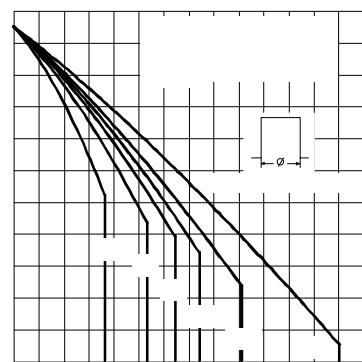


Fig. 2 - Current Ratings Characteristics